



SPECIFICATION FOR LCM+CTP Module

MODULE No:	KD040HVFMD081-C050A
CUSTOMER:	

STARTEK	INITIAL	DATE
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1. Basic Specifications

* Description

This is a color active matrix TFT (Thin Film Transistor) LCD (liquid crystal display) that uses amorphous silicon TFT as a switching device. This module is composed of a Transmissive type TFT-LCD Panel, driver circuit, capacitance touch panel, back-light unit. The resolution of a 4.0" TFT-LCD contains 320x320 pixels, and can display up to 16.7M colors.

1.1 TFT Features

General Information Items	Specification	Unit	Note
	Main Panel		
Display area(AA)	71.14(H)*69.82(V) (4.0 inch)	mm	
Driver element	TFT active matrix	-	
Display colors	16.7M	colors	
Number of pixels	320(RGB)*320	dots	
Pixel arrangement	RGB vertical stripe	-	
Pixel pitch	0.2223(H)*0.2182(V)	mm	
Viewing angle	ALL	o'clock	
Controller IC	ST7796	-	
LCM Interface	3/4serial	-	
	8/9/16/18bit MCU		
Display mode	3/4SPI+16/18BIT RGB	-	
	Transmissive /Normally Black		
Operating temperature	-20 ~ +70	°C	
Storage temperature	-30 ~ +80	°C	
Module bonding technology	Optical bonding between LCM and CTP	-	

1.2 CTP Features

General Information Items	Specification	Unit	Note
	Main Panel		
Resolution	320(H)*320(V)	-	
Structure	G+G	-	
Controller IC	GT911	-	
Interface	I2C	-	
Slave Address	0x5D(7bit) or 0x14(7bit)	-	

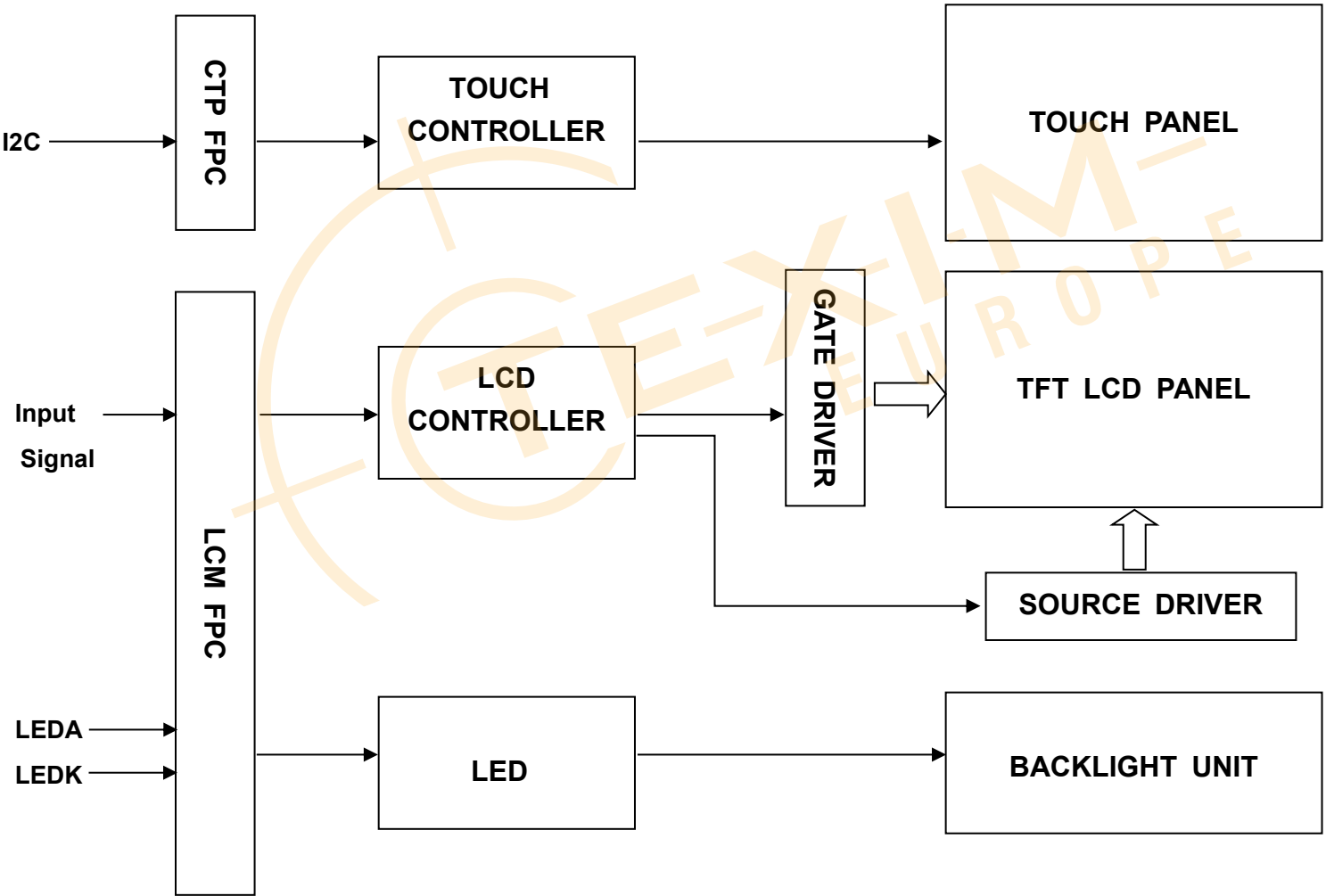
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Touch mode	Five points and Gestures	-	
Logic level	3.3	V	Set by VDDIO

1.3 Mechanical Information

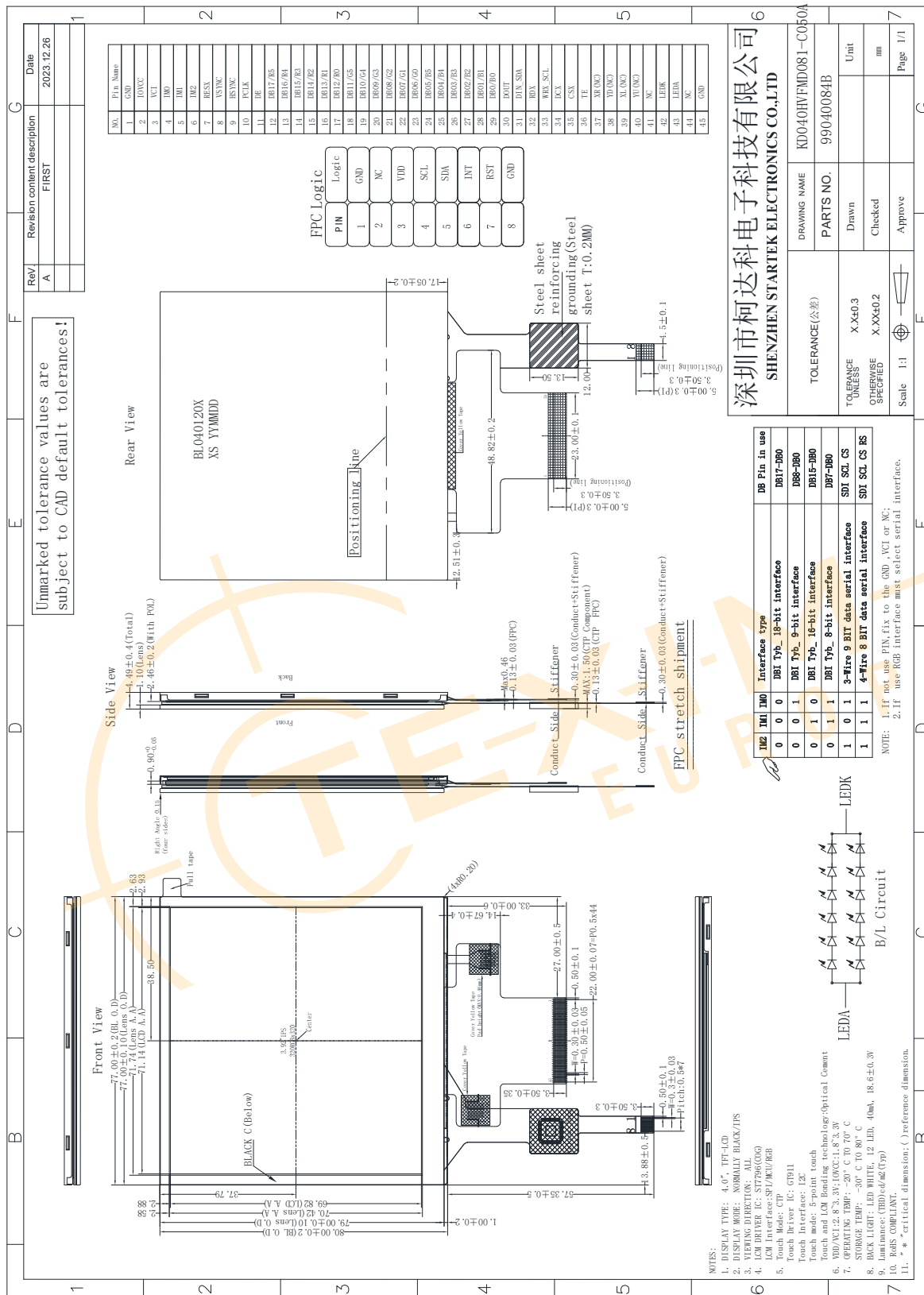
Item		Min.	Typ.	Max.	Unit	Note
Module size	Horizontal(H)	-	77	-	mm	
	Vertical(V)	-	80	-	mm	
	Depth(D)	-	4.49	--	mm	
Weight		-	58	-	g	

2. Block Diagram





3. Outline dimension



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4. Input terminal Pin Assignment

4.1 TFT PIN Define

NO.	SYMBOL	DISCRIPTION					I/O
1	GND	Ground.					P
2	IOVCC	Supply voltage for IO(1.8-3.3V)					P
3	VCI	Supply voltage(3.3V).					P
4	IM0	IM2	IM1	IM0	Interface type	DB Pin in use	I
5	IM1	0	0	0	DBI Tyb_ 18-bit interface	DB17-DB0	
6	IM2	0	0	1	DBI Tyb_ 9-bit interface	DB8-DB0	
		0	1	0	DBI Tyb_ 16-bit interface	DB15-DB0	
		0	1	1	DBI Tyb_ 8-bit interface	DB7-DB0	
		1	0	1	3-Wire 9 BIT data serial interface	SDA SCL CS	
		1	1	1	4-Wire 8 BIT data serial interface	SDA SCL CS RS	
7	RESX	- This signal will reset the device and it must be applied to properly initialize the chip. - Signal is active low.					I
8	VSYNC	Frame synchronizing signal for RGB interface operation. fix this pin at VCI or GND when not in use.					I
9	HSYNC	Line synchronizing signal for RGB interface operation. fix this pin at VCI or GND when not in use					I
10	PCLK	Dot clock signal for RGB interface operation Fix this pin at VCI or GND when not in use.					I
11	DE	Data enable signal for RGB interface operation. fix this pin at VCI or GND when not in use.					I
12-29	DB17-DB0	18-bit parallel bi-directional data bus for MCU system and RGB interface mode . Fix to GND level when not in use					I/O
30	DOUT	- SPI interface output pin. - The data is outputted on the falling edge of the SCL signal. - If not used, please fix this pin at floating.					O
31	DIN_SDA	- SPI interface input/output pin. - The data is latched on the rising edge of the SCL signal. - If not used, please fix this pin GND level.					I



32	RDX	- Read enable in 8080 MCU parallel interface. Low-active. - If not used, please fix this pin GND level.	I
33	WRX_SCL	- Write enable in MCU parallel interface. - In SPI mode, this pin is used as SCL. - If not used, please fix this pin GND level.	I
34	DCX	-Display data/command selection (RS) pin in MCU interface. DCX=' 1' : display data or parameter. DCX=' 0' : register index / command. - If not used, please fix this pin at GND level.	I
35	CSX	Chip select input pin ("Low" enable). fix this pin at VCI or GND when not in use.	I
36	TE	Serve as a TE (Tearing Effect) output signal Leave the pin open when not in use	O
37	XR(NC)	Touch panel Right Glass Terminal	A/D
38	YD(NC)	Touch panel Bottom Film Terminal	A/D
39	XL(NC)	Touch panel LEFT Glass Terminal	A/D
40	YU(NC)	Touch panel Top Film Terminal	A/D
41	NC	NC	
42	LEDK	Cathode pin OF backlight	P
43	LEDA	Anode pin of backlight	P
44	NC	NC	
45	GND	Ground.	P

4.2 CTP PIN Define

NO.	SYMBOL	DISCRIPTION	I/O
1	GND	Ground.	P
2	NC	No Connection	P
3	VDD	Supply voltage.	P
4	SCL	I2C clock input.	I
5	SDA	I2C data input and output	I/O
6	INT	External interrupt to the host.	I
7	RST	External Reset, Low is active.	I
8	GND	Ground.	P

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5. LCD Optical Characteristics

5.1 Optical specification

Item		Symbol	Condition	Min.	Typ.	Max.	Unit.	Note
Contrast Ratio		CR	$\Theta=0$ Normal viewing angle	1000	1200	--		(1)(2)
Response time	Rising	T_{R+T_F}		--	25	35	msec	(1)(3)
	Falling							
Color Gamut		S(%)		47	52	--	%	
Color Filter Chromaticity	White	W_X		0.3031	0.3045	0.3059		(1)(4) CA-310
		W_Y		0.3422	0.3435	0.3505		
	Red	R_X		0.6084	0.6044	0.6057		
		R_Y		0.3393	0.3379	0.3388		
	Green	G_X		0.3131	0.3126	0.3132		
		G_Y		0.5470	0.5474	0.5511		
	Blue	B_X		0.1478	0.1478	0.1486		
		B_Y		0.0930	0.0944	0.0977		
Viewing angle	Hor.	Θ_L	CR>10	75	85	--		(1)(4)
		Θ_R		75	85	--		
	Ver.	Θ_U		75	85	--		
		Θ_D		75	85	--		
		Option View Direction		ALL				

*The data comes from the LCD specification.

Measuring Condition

Measuring surrounding : dark room

Ambient temperature : $25 \pm 2^\circ\text{C}$

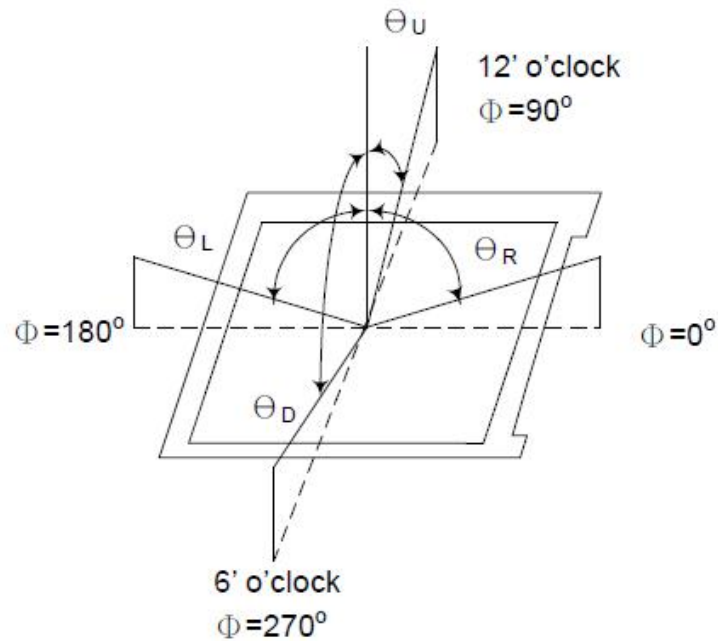
15min. warm-up time.

Measuring Equipment

FPM520 of Westar Display technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics.

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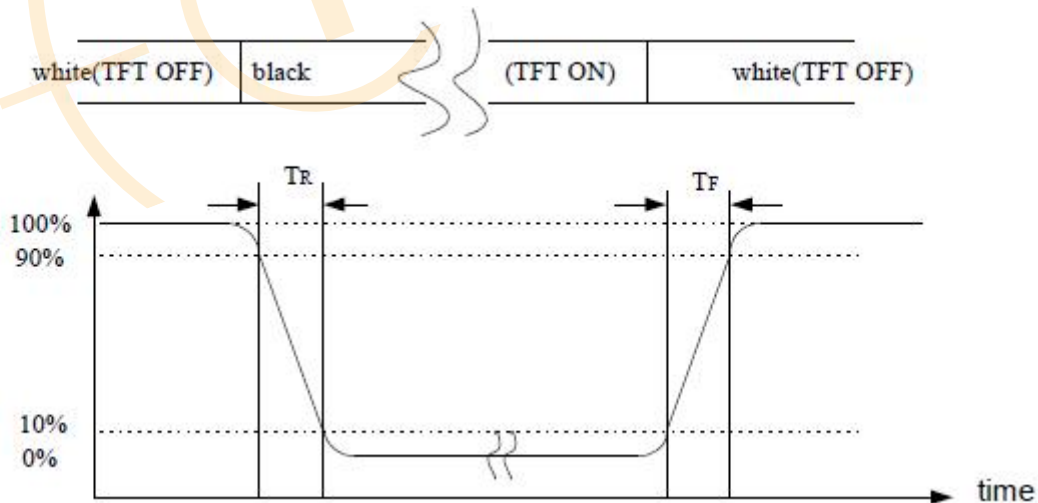
Note (1): Definition of Viewing Angle :



Note (2): Definition of Contrast Ratio(CR) :measured at the center point of panel

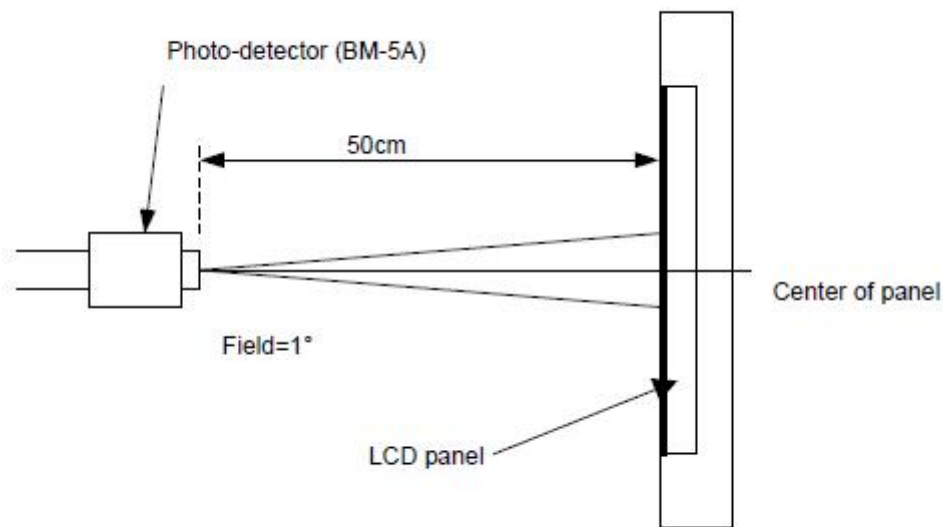
$$CR = \frac{\text{Luminance with all pixels white}}{\text{Luminance with all pixels black}}$$

Note (3): Response Time



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Note (4): Definition of optical measurement setup



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6. Electrical Characteristics

6.1 Absolute Maximum Rating

Characteristics	Symbol	Min.	Max.	Unit	Note
Digital Supply Voltage	V _{CI}	-0.3	+3.6	V	Note1
Digital interface supply Voltage	IOVCC	-0.3	+3.3	V	Note1
Operating temperature	T _{OP}	-20	+70	°C	
Storage temperature	T _{ST}	-30	+80	°C	

NOTE1: If the absolute maximum rating of even is one of the above parameters is exceeded even momentarily, the quality of the product may be degraded. Absolute maximum ratings, therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the range of the absolute maximum ratings.

6.2 DC Electrical Characteristics

Characteristics	Symbol	Min.	Typ.	Max.	Unit	Note
Digital Supply Voltage	V _{CI}	2.5	3.3	3.6	V	
Digital interface supply Voltage	IOVCC	1.65	1.8	3.3	V	
Normal mode Current consumption	IDD	--	18	36	mA	
Level input voltage	V _{IH}	0.7*IOVCC		IOVCC	V	
	V _{IL}	GND		0.3*IOVCC	V	
Level output voltage	V _{OH}	0.8*IOVCC		IOVCC	V	
	V _{OL}	GND		0.2*IOVCC	V	

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6.3 LED Backlight Characteristics

The back-light system is edge-lighting type with 6 chips LED

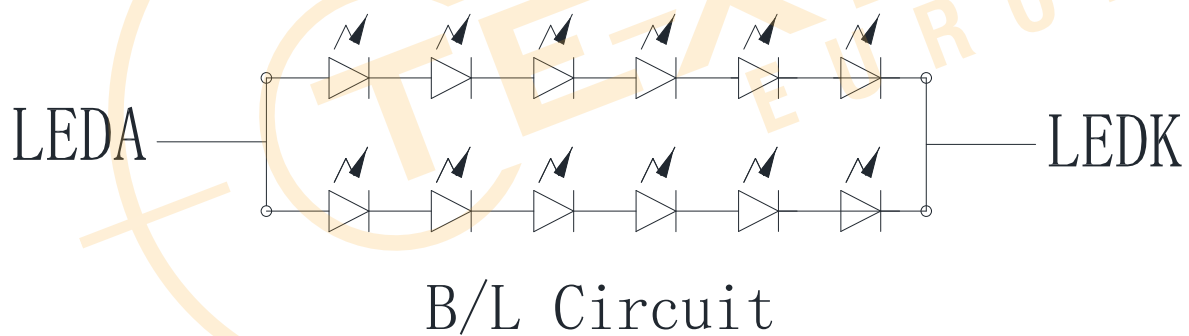
Item	Symbol	Min.	Typ.	Max.	Unit	Note
Forward Current	I_F	--	40	--	mA	
Forward Voltage	V_F	16.8	18.05	20.4	V	
LCM Luminance	L_v	800	900	--	cd/m ²	Note3
LED life time	Hr	50000	--	--	Hour	Note1,2
Uniformity	Avg	80	--	--	%	Note3

Note1: LED life time (Hr) can be defined as the time in which it continues to operate under the condition:

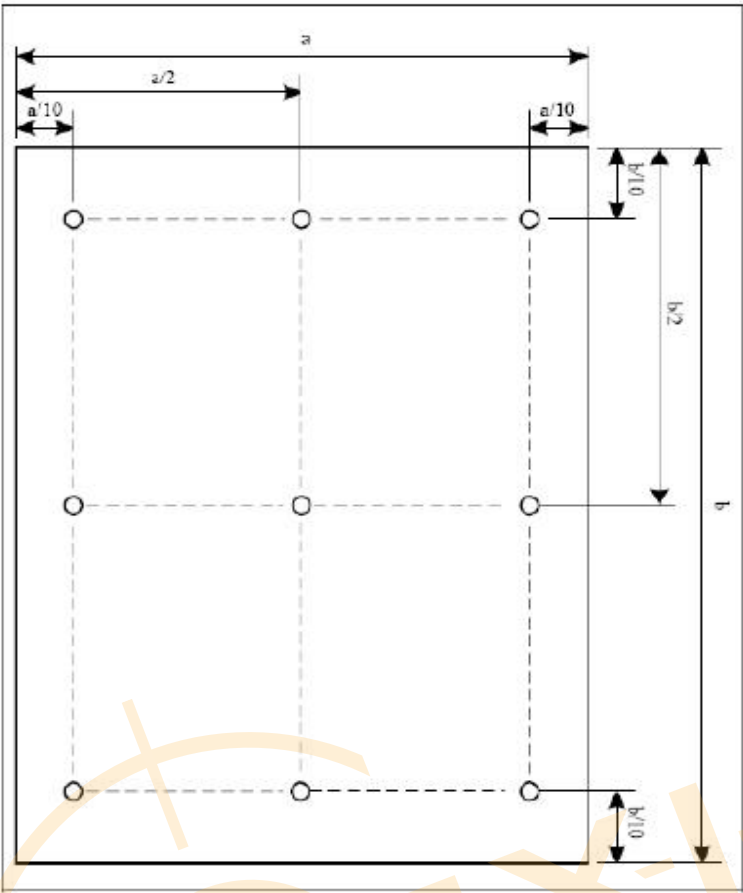
$T_a = 25 \pm 3^\circ \text{C}$, typical IL value indicated in the above table until the brightness becomes less than 50%.

Note 2: The “LED life time” is defined as the module brightness decrease to 50% original brightness at

$T_a = 25^\circ \text{C}$ and $I_L = 40 \text{mA}$. The LED lifetime could be decreased if operating I_L is larger than 40mA. The constant current driving method is suggested.



Note (3) Luminance Uniformity of these 9 points is defined as below:



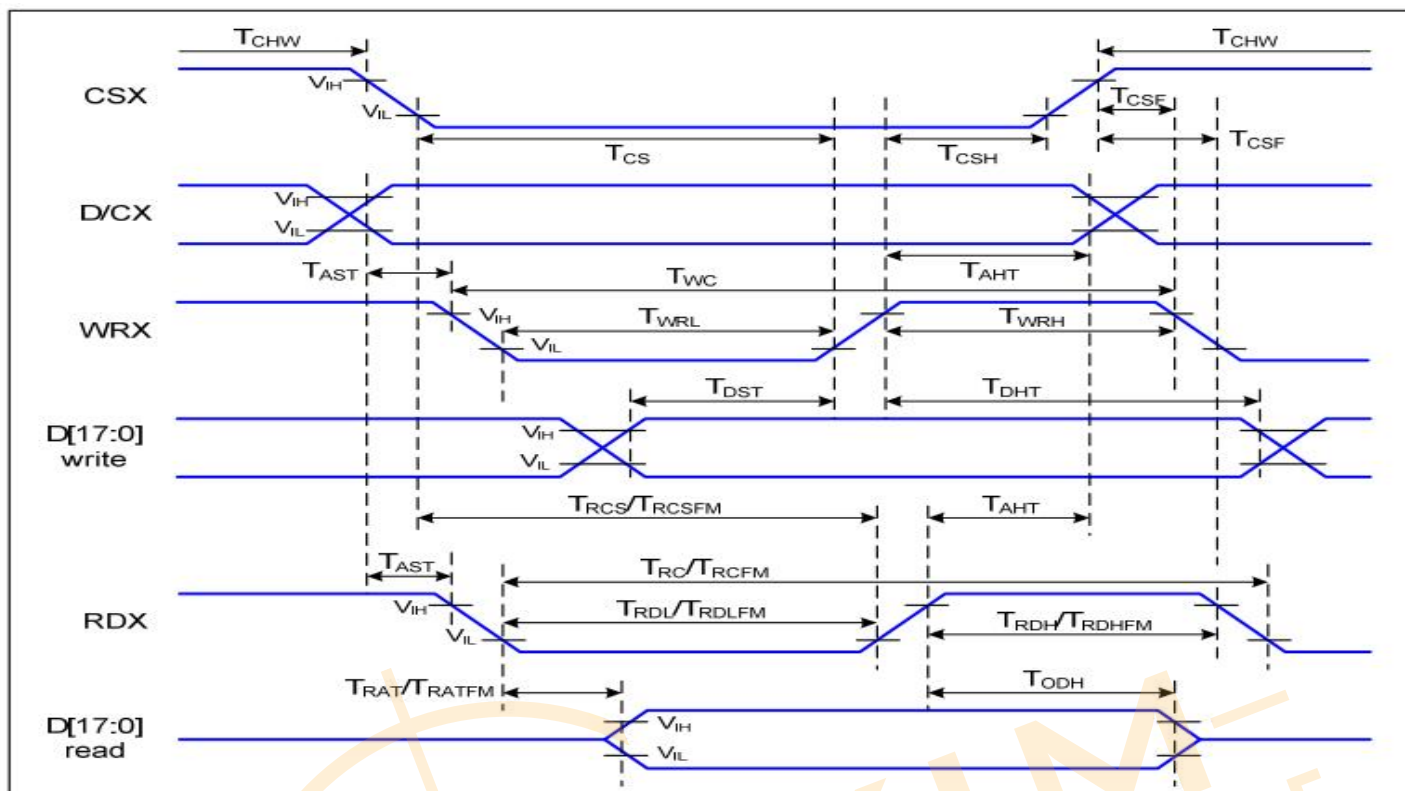
$$\text{Uniformity} = \frac{\text{minimum luminance in 9 points (1-9)}}{\text{maximum luminance in 9 points (1-9)}}$$

$$\text{Luminance} = \frac{\text{Total Luminance of 9 points}}{9}$$

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7. AC Characteristics

7.1 8080 Series MCU Parallel Interface Characteristics: 18/16/9/8-bit Bus



Parallel Interface Timing Characteristics (8080-Series MCU Interface)

$V_{DDI}=1.8V, V_{DDA}=2.8V, AGND=DGND=0V, T_a=25^{\circ}C$

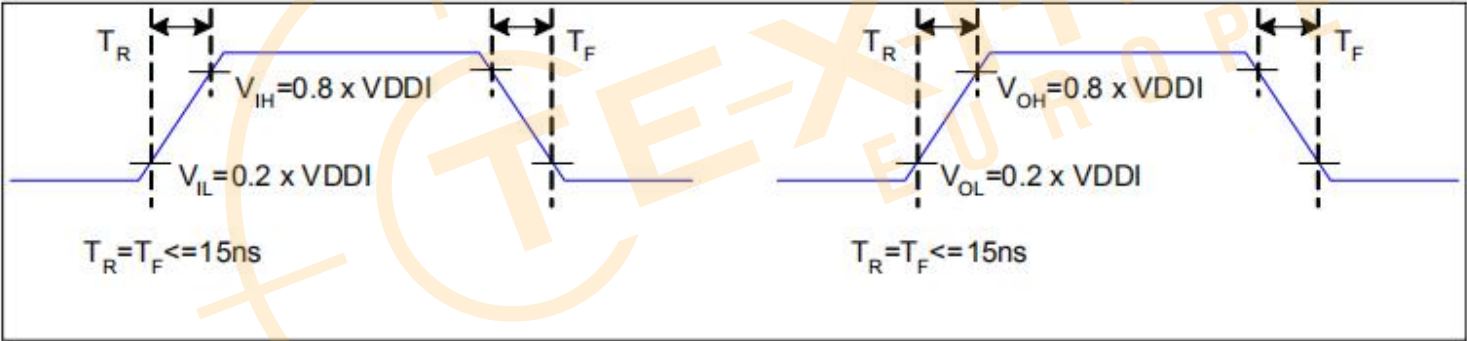
Signal	Symbol	Parameter	Min	Max	Unit	Description
D/CX	T_{AST}	Address setup time	0		ns	-
	T_{AHT}	Address hold time (Write/Read)	10		ns	
CSX	T_{CHW}	Chip select "H" pulse width	0		ns	-
	T_{CS}	Chip select setup time (Write)	15		ns	
	T_{RCS}	Chip select setup time (Read ID)	45		ns	
	T_{RCSFM}	Chip select setup time (Read FM)	355		ns	
	T_{CSF}	Chip select wait time (Write/Read)	10		ns	
	T_{CSH}	Chip select hold time	10		ns	
WRX	T_{WC}	Write cycle	66		ns	-
	T_{WRH}	Control pulse "H" duration	15		ns	

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	T_{WRL}	Control pulse "L" duration	15		ns	
RDX (ID)	T_{RC}	Read cycle (ID)	160		ns	When read ID data
	T_{RDH}	Control pulse "H" duration (ID)	90		ns	
	T_{RDL}	Control pulse "L" duration (ID)	45		ns	
RDX (FM)	T_{RCFM}	Read cycle (FM)	450		ns	When read from frame memory
	T_{RDHFM}	Control pulse "H" duration (FM)	90		ns	
	T_{RDLFM}	Control pulse "L" duration (FM)	355		ns	
D[17:0]	T_{DST}	Data setup time	10		ns	For CL=30pF
	T_{DHT}	Data hold time	10		ns	
	T_{RAT}	Read access time (ID)	-	40	ns	
	T_{RATFM}	Read access time (FM)	-	340	ns	
	T_{ODH}	Output disable time	20	80	ns	

8080 Parallel Interface Characteristics

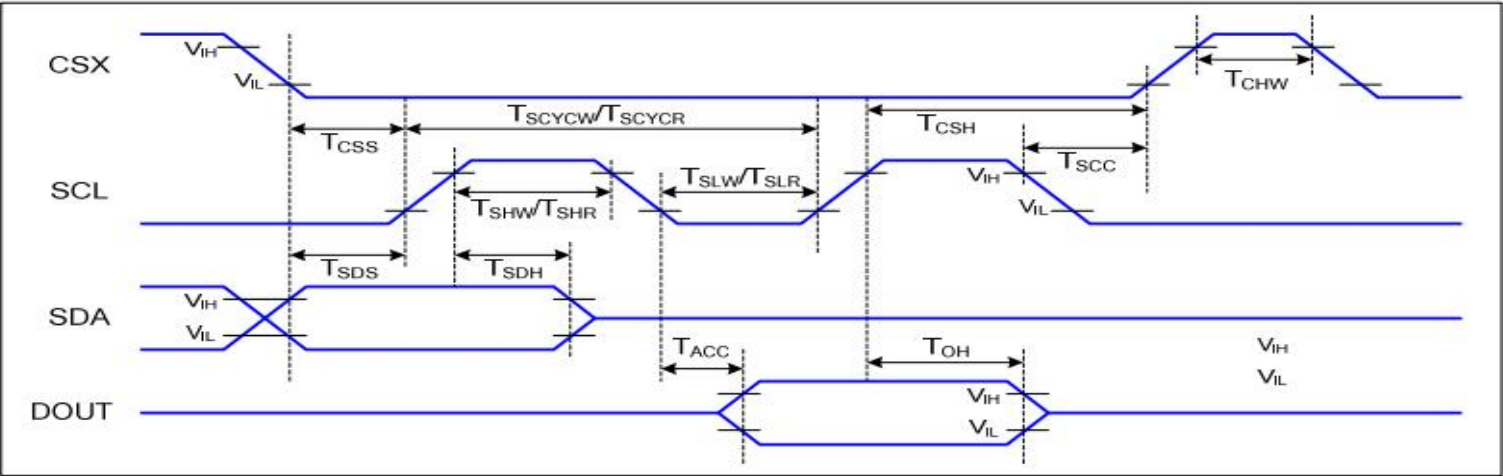


Rising and Falling Timing for I/O Signal

Note: The rising time and falling time (T_r , T_f) of input signal and fall time are specified at 15 ns or less. Logic high and low levels are specified as 20% and 80% of VDDI for Input signals.

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7.2 3-SPI Serial Data Transfer Interface Characteristics:



3-SPI Interface Timing Characteristics

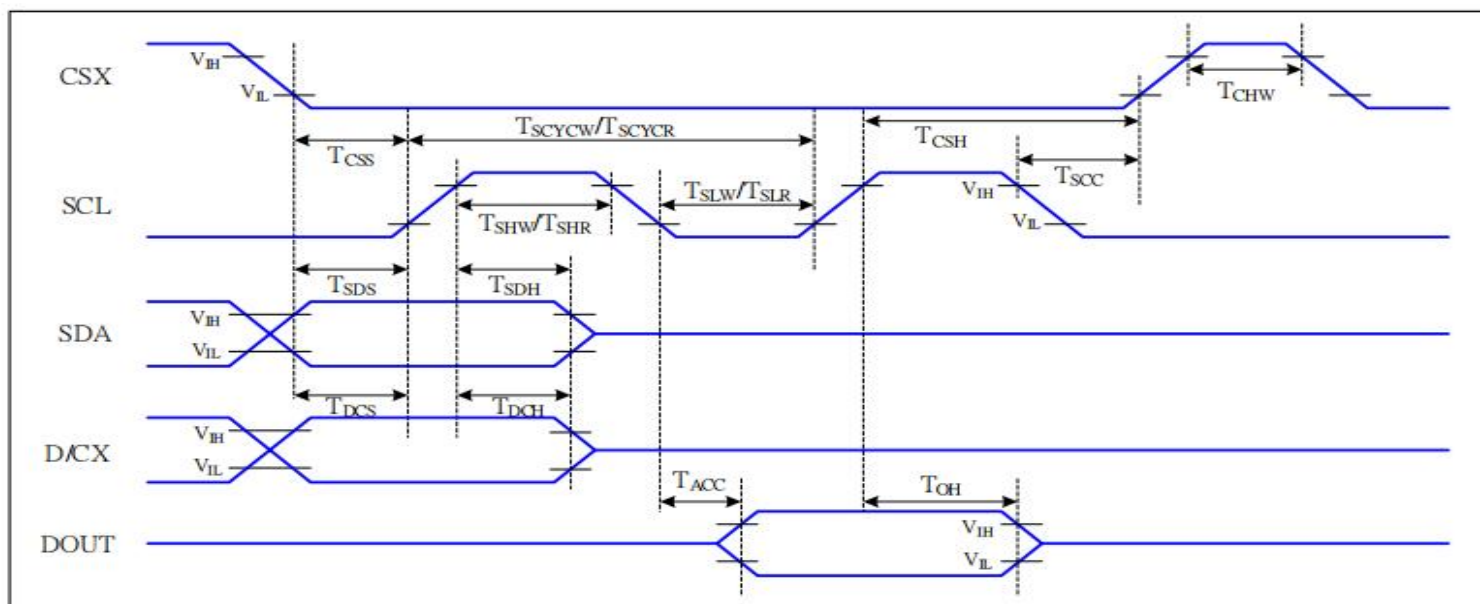
$V_{DDI}=1.8V, V_{DDA}=2.8V, AGND=DGND=0V, T_a=25^{\circ}C$

Signal	Symbol	Parameter	Min	Max	Unit	Description
CSX	T_{CSS}	Chip select setup time (write)	15		ns	
	T_{CSH}	Chip select hold time (write)	15		ns	
	T_{CSS}	Chip select setup time (read)	60		ns	
	T_{SCC}	Chip select hold time (read)	65		ns	
	T_{CHW}	Chip select "H" pulse width	40		ns	
SCL	T_{SCYCW}	Serial clock cycle (Write)	66		ns	
	T_{SHW}	SCL "H" pulse width (Write)	15		ns	
	T_{SLW}	SCL "L" pulse width (Write)	15		ns	
	T_{SCYCR}	Serial clock cycle (Read)	150		ns	
	T_{SHR}	SCL "H" pulse width (Read)	60		ns	
	T_{SLR}	SCL "L" pulse width (Read)	60		ns	
SDA (DIN)	T_{SDS}	Data setup time	10		ns	
	T_{SDH}	Data hold time	10		ns	
DOUT	T_{ACC}	Access time	10	50	ns	For maximum CL=30pF
	T_{OH}	Output disable time	15	50	ns	For minimum CL=8pF

3-SPI Interface Characteristics

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7.3 4-SPI Serial Data Transfer Interface Characteristics:

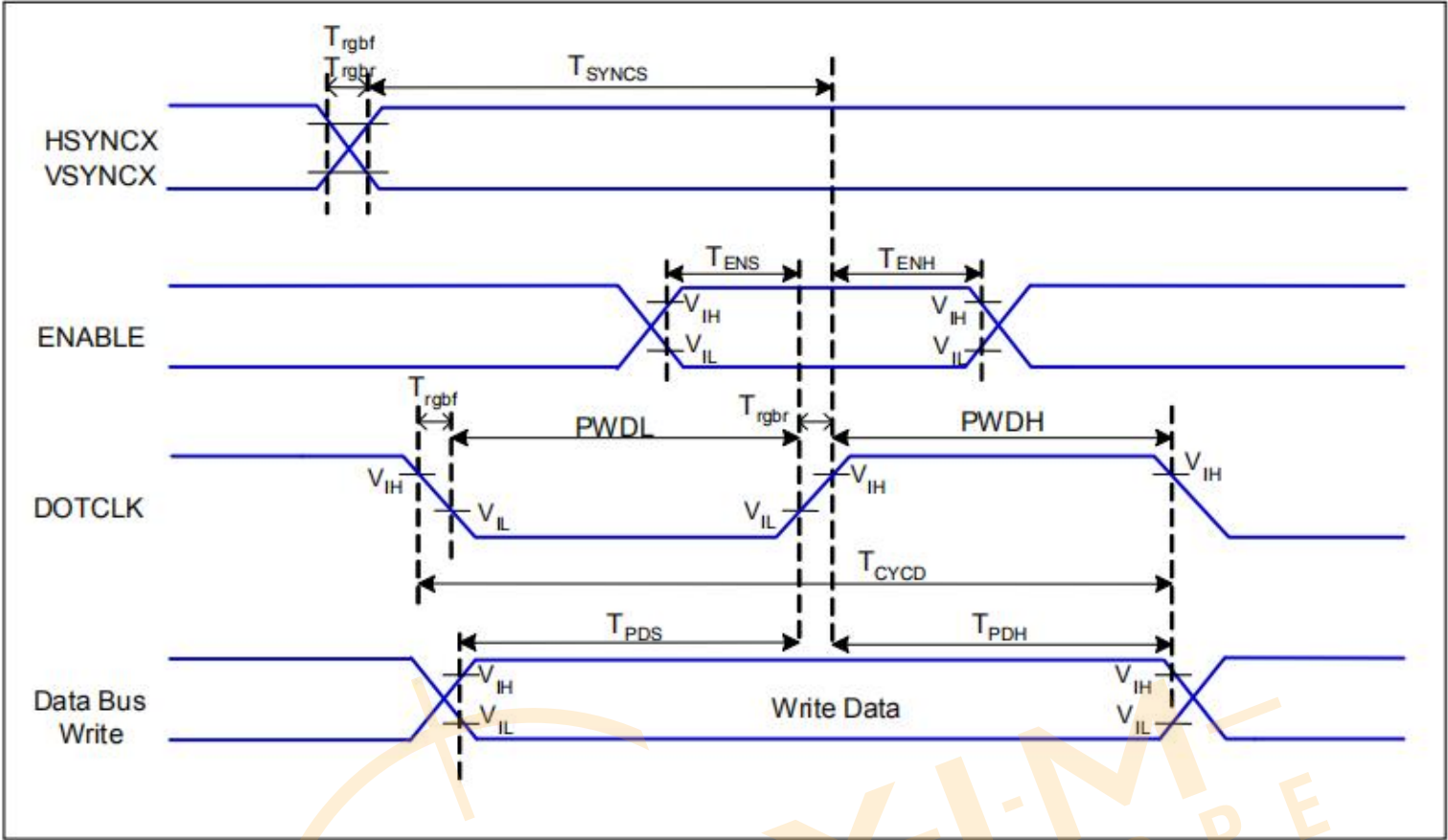


4-SPI Interface Timing Characteristics

VDDI=1.8V, VDDA=2.8V, AGND=DGND=0V, $T_a=25^\circ\text{C}$

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
CSX	T_{CSS}	Chip select setup time (write)	15		ns	
	T_{CSH}	Chip select hold time (write)	15		ns	
	T_{CSS}	Chip select setup time (read)	60		ns	
	T_{SCC}	Chip select hold time (read)	65		ns	
	T_{CHW}	Chip select "H" pulse width	40		ns	
SCL	T_{SCYCW}	Serial clock cycle (Write)	66		ns	-write command & data ram
	T_{SHW}	SCL "H" pulse width (Write)	15		ns	
	T_{SLW}	SCL "L" pulse width (Write)	15		ns	
	T_{SCYCR}	Serial clock cycle (Read)	150		ns	-read command & data ram
	T_{SHR}	SCL "H" pulse width (Read)	60		ns	
	T_{SLR}	SCL "L" pulse width (Read)	60		ns	
D/CX	T_{DCS}	D/CX setup time	10		ns	
	T_{DCH}	D/CX hold time	10		ns	
SDA (DIN)	T_{SDS}	Data setup time	10		ns	
	T_{SDH}	Data hold time	10		ns	
DOUT	T_{ACC}	Access time	10	50	ns	For maximum CL=30pF
	T_{OH}	Output disable time	15	50	ns	For minimum CL=8pF

7.4 RGB Interface Characteristics:



VDDI=1.8V, VDDA=2.8V, AGND=DGND=0V, Ta=25℃

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
HSYNC, VSYNC	T_{SYNCS}	VSYNC, HSYNC Setup Time	15	-	ns	
ENABLE	T_{ENS}	Enable Setup Time	15	-	ns	
	T_{ENH}	Enable Hold Time	15	-	ns	
DOTCLK	PWDH	DOTCLK High-level Pulse Width	30	-	ns	
	PWDL	DOTCLK Low-level Pulse Width	30	-	ns	
	T_{CYCD}	DOTCLK Cycle Time	66	-	ns	
	Trghr, Trghf	DOTCLK Rise/Fall time	-	15	ns	
DB	T_{PDS}	PD Data Setup Time	15	-	ns	
	T_{PDH}	PD Data Hold Time	15	-	ns	

RGB Interface Timing Characteristics

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Please refer to the following table for the setting limitation of RGB interface signals.

Parameter	Symbol	Min.	Typ.	Max.	Unit
DCLK frequency	FCLK	--	(7)	--	MHz
Horizontal Sync. Width	hpw	1	(2)	255	Clock
Horizontal Sync. Back Porch	hbp	1	(4)	255	Clock
Horizontal Sync. Front Porch	hfp	1	(10)	--	Clock
Vertical Sync. Width	vs	1	(2)	254	Line
Vertical Sync. Back Porch	vbp	1	(8)	254	Line
Vertical Sync. Front Porch	vfp	1	(17)	--	Line

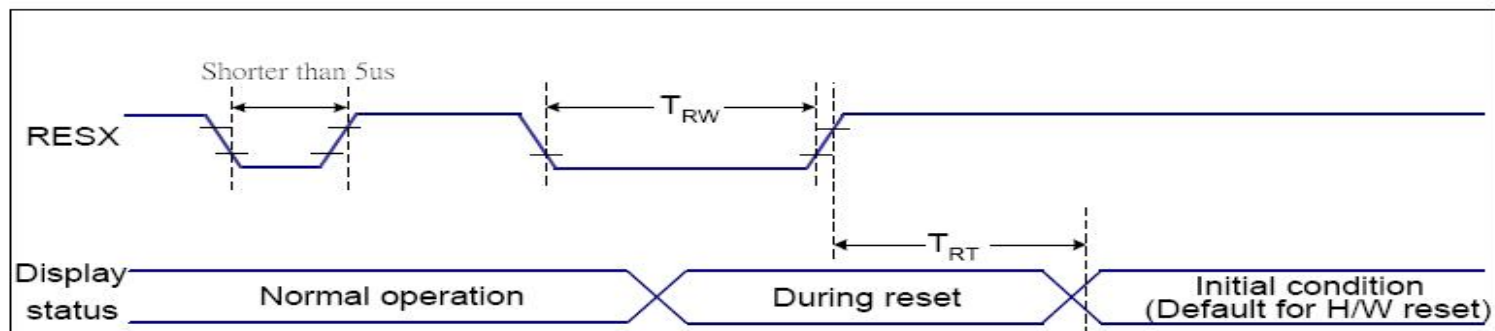
Note:

1. Typical value are related to the setting frame rate is 60Hz..



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7.5 Reset timing



$V_{DDI}=1.65$ to $3.3V$, $V_{DD}=2.4$ to $3.3V$, $AGND=DGND=0V$, $T_a=-30 \sim 70^\circ C$

Related Pins	Symbol	Parameter	MIN	MAX	Unit
RESX	TRW	Reset pulse duration	10	-	us
	TRT	Reset cancel	-	5 (Note 1, 5)	ms
				120 (Note 1, 6, 7)	ms

Notes:

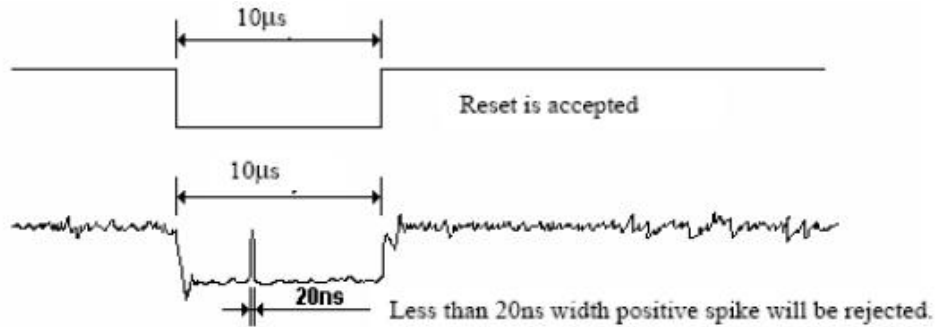
- The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (t_{RT}) within 5 ms after a rising edge of RESX.
- Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

- During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.

- Spike Rejection also applies during a valid reset pulse as shown below:

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5. When Reset applied during Sleep In Mode.

6. When Reset applied during Sleep Out Mode.

7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.



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8. CTP Specification

8.1 Electrical Characteristics

8.1.1 Absolute Maximum Rating

Item	Symbol	Min.	Max.	Unit	Note
Power Supply Voltage	VDD	2.66	3.47	V	1
Operating temperature	T _{OP}	-30	+80	°C	-
Storage temperature	T _{ST}	-30	+85	°C	-

NOTES:

- If used beyond the absolute maximum ratings, FT5446U may be permanently damaged. It is strongly recommended that the device be used within the electrical characteristics in normal operations. If exposed to the condition not within the electrical characteristics, it may affect the reliability of the device.

8.1.2 DC Electrical Characteristics (Ta=25°C)

Item	Min.	Typ.	Max.	Unit	Note
Power Supply Voltage/VDD	2.66	3.3	3.47	V	
Normal mode operating current	--	8	14.5	mA	
Green mode operating current	--	3.3	--	mA	
Sleep mode operating current	70	--	120	uA	
Doze mode operating current	--	0.78	--	mA	
Digital Input low voltage/VIL	-0.3	--	0.25*VDD	V	
Digital Input high voltage/VIH	0.75*VDD	--	VDD+0.3	V	
Digital Output low voltage/VOL	--	--	0.15*VDD	V	
Digital Output high voltage/VOH	0.85*VDD	--	--	V	

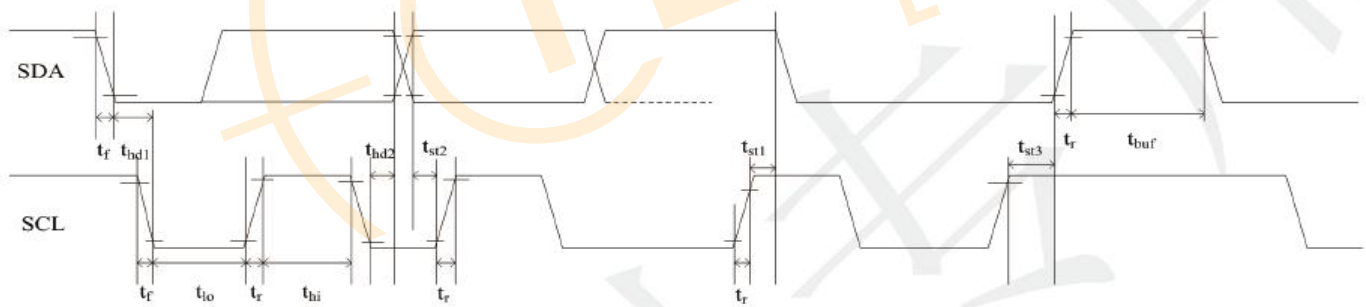
8.2 AC Characteristics

(Ambient temperature:25°C, VDD=2.8V, VDDIO=1.8V)

Parameter	Min	Typ	Max	Unit	Note
OSC oscillation frequency	59	60	61	MHZ	
I/O output rise time,low to high	-	14	-	ns	
I/O output rfall time,high to low	-	14	-	ns	

8.3 I2C Timing

GT911 provides a standard I2C interface for SCL and SDA to communicate with the host. GT911 always serves as slave device in the system with all communication being initialized by the host. It is strongly recommended that transmission rate be kept at or below 400Kbps. The I2C timing is shown below:



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Test condition 1: 1.8V host interface voltage, 400Kbps transmission rate, 2K pull-up resistor

Parameter	Symbol	Min.	Max.	Unit
SCL low period	t_{lo}	1.3	-	us
SCL high period	t_{hi}	0.6	-	us
SCL setup time for Start condition	t_{st1}	0.6	-	us
SCL setup time for Stop condition	t_{st3}	0.6	-	us
SCL hold time for Start condition	t_{hd1}	0.6	-	us
SDA setup time	t_{st2}	0.1	-	us
SDA hold time	t_{hd2}	0	-	us

Test condition 2: 3.3V host interface voltage, 400Kbps transmission rate, 2K pull-up resistor

Parameter	Symbol	Min.	Max.	Unit
SCL low period	t_{lo}	1.3	-	us
SCL high period	t_{hi}	0.6	-	us
SCL setup time for Start condition	t_{st1}	0.6	-	us
SCL setup time for Stop condition	t_{st3}	0.6	-	us
SCL hold time for Start condition	t_{hd1}	0.6	-	us
SDA setup time	t_{st2}	0.1	-	us
SDA hold time	t_{hd2}	0	-	us

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Mnemonics	Description
S	I2C Start or I2C Restart
A[6:0]	Slave address
R/ W	READ/WRITE bit, '1' for read, '0'for write
A(N)	ACK(NACK) bit
P	STOP: the indication of the end of a packet (if this bit is missing, S will indicate the end of the current packet and the beginning of the next packet)

I2C Interface Timing Characteristics is shown in Table 2-2.

Table 2-2 I2C Timing Characteristics

Parameter	Min	Max	Unit
SCL frequency	0	400	KHz
Bus free time between a STOP and START condition	1.3		us
Hold time (repeated) START condition	0.6		us
Data setup time	100		ns
Setup time for a repeated START condition	0.6		us
Setup Time for STOP condition	0.6		us

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9. LCD Module Out-Going Quality Level

9.1 VISUAL & FUNCTION INSPECTION STANDARD

9.1.1 Inspection conditions

Inspection performed under the following conditions is recommended.

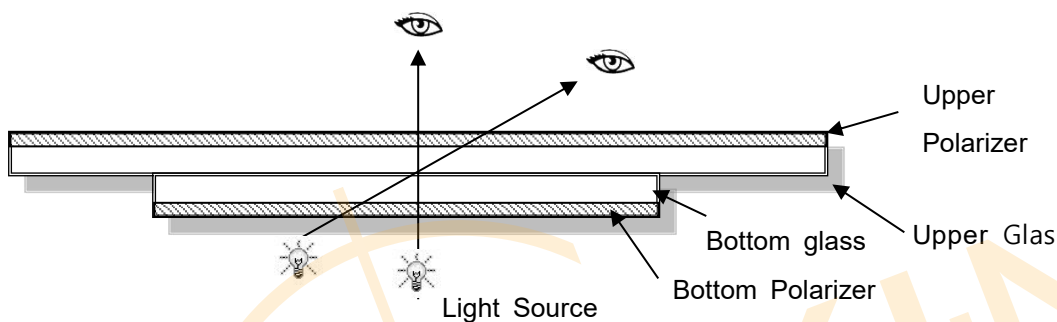
Temperature : $25\pm 5^{\circ}\text{C}$

Humidity : $65\%\pm 10\%\text{RH}$

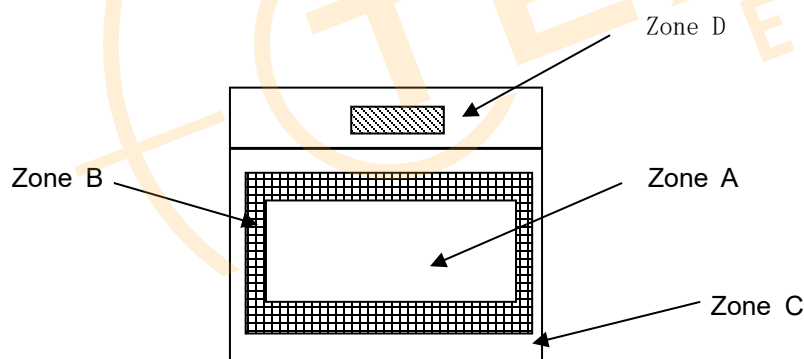
Viewing Angle : Normal viewing Angle.

Illumination: Single fluorescent lamp (300 to 700Lux)

Viewing distance:30-50cm



9.1.2 Definition



Zone A : Effective Viewing Area(Character or Digit can be seen)

Zone B : Viewing Area except Zone A

Zone C : Outside (Zone A+Zone B) which can not be seen after assembly by customer

Zone D : IC Bonding Area

Note:As a general rule ,visual defects in Zone C can be ignored when it doesn't effect product function or appearance after assembly by customer

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9.1.3 Sampling Plan

According to GB/T 2828-2003 ; , normal inspection, Class II

AQL:

Major defect	Minor defect
0.65	1.5

LCD: Liquid Crystal Display , LCM: Liquid Crystal Module, CTP: Capacitive Touch Panel

No	Items to be inspected	Criteria	Classification of defects
1	Functional defects	1) No display, Open or miss line 2) Display abnormally, Short 3) Backlight no lighting, abnormal lighting. etc	Major
2	Missing	Missing components and etc	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed, deformation and etc	
4	Color tone	Color unevenness, refer to limited sample	Minor
5	Spot/Line defect	Light dot, Dim spot, (Note1) Polarizer Air Bubble, Polarizer accidented spot and etc.	
6	Soldering appearance	Good soldering , Peeling off is not allowed and etc.	
7	LCD/Polarizer/CTP	Black/White spot/line, scratch, crack, etc.	

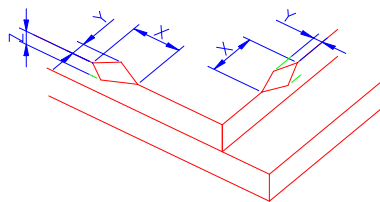
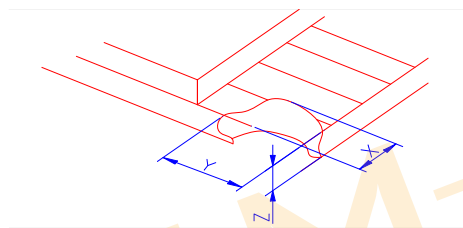
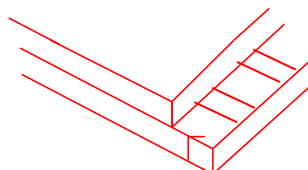
Note1: a) Light dot: Dots appear bright and unchanged in size in which LCD panel is displaying under black pattern.

b) Dim dot: Dots appear dark and unchanged in size in which LCD panel is displaying under pure red, green, blue picture.

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9.1.4 Criteria (Visual)

Number	Items	Criteria(mm)						
1.0 LCD Crack/Broken NOTE: X: Length Y: Width Z: Height L: Length of IT O, T: Height of LCD	(1) The edge of LCD broken	 <table><tr><td>X</td><td>Y</td><td>Z</td></tr><tr><td>≤3.0mm</td><td><Inner border line of the seal</td><td>≤T</td></tr></table>	X	Y	Z	≤3.0mm	<Inner border line of the seal	≤T
	X	Y	Z					
	≤3.0mm	<Inner border line of the seal	≤T					
(2)LCD corner broken	 <table><tr><td>X</td><td>Y</td><td>Z</td></tr><tr><td>≤3.0mm</td><td>≤L</td><td>≤T</td></tr></table>	X	Y	Z	≤3.0mm	≤L	≤T	
X	Y	Z						
≤3.0mm	≤L	≤T						
(3) LCD crack	 Crack Not allowed							



Spot defect

2.0

$\Phi=(X+Y)/2$

① light dot (black/white spot , pinhole, stain, etc.)

Zone Size (mm)	Acceptable Qty		
	A	B	C
$\Phi \leq 0.15$	Ignore	Ignore	
$0.15 < \Phi \leq 0.25$	3(distance $\geq 10\text{mm}$)		
$0.25 < \Phi \leq 0.4$	2(distance $\geq 10\text{mm}$)		
$\Phi > 0.4$	0		

② Dim spot (light leakage、dent、dark spot, etc)

Zone Size (mm)	Acceptable Qty		
	A	B	C
$\Phi \leq 0.15$	Ignore	Ignore	
$0.15 < \Phi \leq 0.25$	3(distance $\geq 10\text{mm}$)		
$0.25 < \Phi \leq 0.4$	2(distance $\geq 10\text{mm}$)		
$\Phi > 0.4$	0		

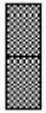
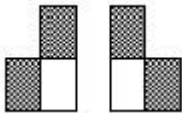
③ Polarizer accidented spot

Zone Size (mm)	Acceptable Qty		
	A	B	C
$\Phi \leq 0.2$	Ignore		Ignore
$0.2 < \Phi \leq 0.5$	2(distance $\geq 10\text{mm}$)		
$\Phi > 0.5$	0		

④Polarizer Bubble

Zone Size (mm)	Acceptable Qty		
	A	B	C
$\Phi \leq 0.2$	Ignore		Ignore
$0.2 < \Phi \leq 0.4$	3(distance $\geq 10\text{mm}$)		
$\Phi > 0.4$	0		



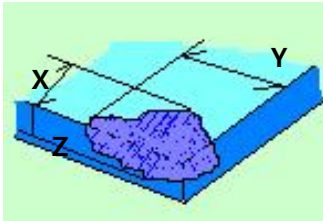
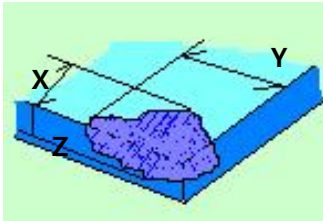
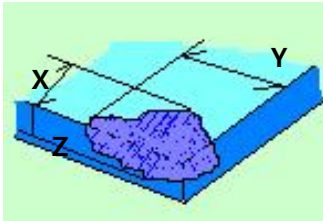
3.0	LCD Pixel defect	Pixel bad points																							
		<table> <tr> <th>Item</th><th>Zone A</th><th>Acceptable Qt</th></tr> <tr> <td rowspan="3">Bright dot</td><td>Random</td><td>$N \leq 2$</td></tr> <tr> <td>2 dots adjacent</td><td>$N \leq 0$</td></tr> <tr> <td>3 dots adjacent</td><td>$N \leq 0$</td></tr> <tr> <td rowspan="3">Dark dot</td><td>Random</td><td>$N \leq 2$</td></tr> <tr> <td>2 dots adjacent</td><td>$N \leq 0$</td></tr> <tr> <td>3 dots adjacent</td><td>$N \leq 0$</td></tr> <tr> <td>Distance</td><td> 1. Minimum Distance Between Bright dots. 2. Minimum Distance Between dark dots 3. Minimum Distance Between dark and bright dot. </td><td>5mm</td></tr> <tr> <td colspan="2">Total bright and dark dot</td><td>$N \leq 4$</td></tr> </table>	Item	Zone A	Acceptable Qt	Bright dot	Random	$N \leq 2$	2 dots adjacent	$N \leq 0$	3 dots adjacent	$N \leq 0$	Dark dot	Random	$N \leq 2$	2 dots adjacent	$N \leq 0$	3 dots adjacent	$N \leq 0$	Distance	1. Minimum Distance Between Bright dots. 2. Minimum Distance Between dark dots 3. Minimum Distance Between dark and bright dot.	5mm	Total bright and dark dot		$N \leq 4$
Item	Zone A	Acceptable Qt																							
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	2 dots adjacent	$N \leq 0$																							
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Distance	1. Minimum Distance Between Bright dots. 2. Minimum Distance Between dark dots 3. Minimum Distance Between dark and bright dot.	5mm																							
Total bright and dark dot		$N \leq 4$																							
		Note: A) Bright dot: Dots appear bright and unchanged in size in which LCD panel is displaying under black pattern. B) Dark dot: Dots appear dark and unchanged in size in which LCD panel is displaying under pure red, green, blue picture. C) 2 dot adjacent = 1 pair = 2 dots Picture:  2 dot adjacent  2 dot adjacent  2 dot adjacent (vertical)  2 dot adjacent (slant)																							



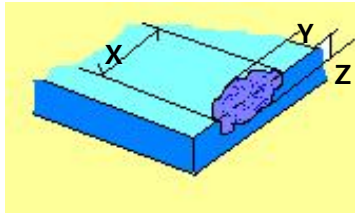
4.0	Line defect (LCD /Polarizer backlight black/white line, scratch, stain)				
					
	W: width, L : length				
	N : Count				

8.0	CTP Related	CTP Cover sensor acc identified black/white spot	Size Φ (mm)	Acceptable Qty		
			A		B	C
			$\Phi \leq 0.1$	Ignore		Ignore
			$0.1 < \Phi \leq 0.2$			
			$0.20 < \Phi \leq 0.25$			
			$\Phi > 0.25$	0		



		<table><tr><td rowspan="6">CTP Cover scratch</td><td>Width(mm)</td><td>Ignore (mm)</td><td colspan="3">Acceptable Qty</td></tr><tr><td></td><td></td><td>A</td><td>B</td><td>C</td></tr><tr><td>$\Phi \leq 0.05$</td><td>Ignore</td><td colspan="3">Ignore</td></tr><tr><td>$0.05 < W \leq 0.06$</td><td>$L \leq 4.0$</td><td colspan="3">$N \leq 3$</td></tr><tr><td>$0.06 < W \leq 0.08$</td><td>$L \leq 3.0$</td><td colspan="3">$N \leq 2$</td></tr><tr><td>$0.08 < W$</td><td colspan="4">Define as spot defect</td></tr></table>	CTP Cover scratch	Width(mm)	Ignore (mm)	Acceptable Qty					A	B	C	$\Phi \leq 0.05$	Ignore	Ignore			$0.05 < W \leq 0.06$	$L \leq 4.0$	$N \leq 3$			$0.06 < W \leq 0.08$	$L \leq 3.0$	$N \leq 2$			$0.08 < W$	Define as spot defect			
CTP Cover scratch	Width(mm)	Ignore (mm)		Acceptable Qty																													
				A	B	C																											
	$\Phi \leq 0.05$	Ignore		Ignore																													
	$0.05 < W \leq 0.06$	$L \leq 4.0$		$N \leq 3$																													
	$0.06 < W \leq 0.08$	$L \leq 3.0$		$N \leq 2$																													
	$0.08 < W$	Define as spot defect																															
	<table><tr><td rowspan="6">CTP Cover Pinhole/ Lack of ink</td><td> Zone Size (mm) </td><td>Acceptable Qty</td></tr><tr><td></td><td>C</td></tr><tr><td>$\Phi \leq 0.1$</td><td>Ignore</td></tr><tr><td>$0.1 < \Phi \leq 0.25$</td><td>3(distance $\geq 10\text{mm}$)</td></tr><tr><td>$0.25 < \Phi \leq 0.3$</td><td>2(distance $\geq 10\text{mm}$)</td></tr><tr><td>$\Phi > 0.3$</td><td>0</td></tr></table>	CTP Cover Pinhole/ Lack of ink	Zone Size (mm)	Acceptable Qty		C	$\Phi \leq 0.1$	Ignore	$0.1 < \Phi \leq 0.25$	3(distance $\geq 10\text{mm}$)	$0.25 < \Phi \leq 0.3$	2(distance $\geq 10\text{mm}$)	$\Phi > 0.3$	0																			
CTP Cover Pinhole/ Lack of ink	Zone Size (mm)		Acceptable Qty																														
			C																														
	$\Phi \leq 0.1$		Ignore																														
	$0.1 < \Phi \leq 0.25$		3(distance $\geq 10\text{mm}$)																														
	$0.25 < \Phi \leq 0.3$		2(distance $\geq 10\text{mm}$)																														
	$\Phi > 0.3$	0																															
	<table><tr><td rowspan="6">CTP Bonding bubble/ accident spot</td><td>Size $\Phi(\text{mm})$</td><td colspan="2">Acceptable Qty</td></tr><tr><td></td><td>A</td><td>B</td></tr><tr><td>$\Phi \leq 0.1$</td><td colspan="2">Ignore</td></tr><tr><td>$0.1 < \Phi \leq 0.2$</td><td colspan="2">3(distance $\geq 10\text{mm}$)</td></tr><tr><td>$0.2 < \Phi \leq 0.25$</td><td colspan="2">2(distance $\geq 10\text{mm}$)</td></tr><tr><td>$\Phi > 0.25$</td><td colspan="2">0</td></tr></table>	CTP Bonding bubble/ accident spot	Size $\Phi(\text{mm})$	Acceptable Qty			A	B	$\Phi \leq 0.1$	Ignore		$0.1 < \Phi \leq 0.2$	3(distance $\geq 10\text{mm}$)		$0.2 < \Phi \leq 0.25$	2(distance $\geq 10\text{mm}$)		$\Phi > 0.25$	0														
CTP Bonding bubble/ accident spot	Size $\Phi(\text{mm})$		Acceptable Qty																														
			A	B																													
	$\Phi \leq 0.1$		Ignore																														
	$0.1 < \Phi \leq 0.2$		3(distance $\geq 10\text{mm}$)																														
	$0.2 < \Phi \leq 0.25$		2(distance $\geq 10\text{mm}$)																														
	$\Phi > 0.25$	0																															
	<table><tr><td>Assembly deflection</td><td colspan="3">beyond the edge of backlight $\leq 0.2\text{mm}$</td></tr></table>	Assembly deflection	beyond the edge of backlight $\leq 0.2\text{mm}$																														
Assembly deflection	beyond the edge of backlight $\leq 0.2\text{mm}$																																
<table><tr><td>CTP cover broken</td><td><table><tr><td>X</td><td>Y</td><td>Z</td></tr><tr><td>$X \leq 0.5\text{mm}$</td><td>$Y \leq 0.5\text{mm}$</td><td>$Z < \text{cover t hickness}$</td></tr></table></td><td rowspan="4"></td></tr><tr><td>X : length</td><td></td></tr><tr><td>Y : width</td><td></td></tr><tr><td>Z : height</td><td></td></tr></table>	CTP cover broken	<table><tr><td>X</td><td>Y</td><td>Z</td></tr><tr><td>$X \leq 0.5\text{mm}$</td><td>$Y \leq 0.5\text{mm}$</td><td>$Z < \text{cover t hickness}$</td></tr></table>	X	Y	Z	$X \leq 0.5\text{mm}$	$Y \leq 0.5\text{mm}$	$Z < \text{cover t hickness}$		X : length		Y : width		Z : height		* Circuitry broken is not allowed.																	
CTP cover broken	<table><tr><td>X</td><td>Y</td><td>Z</td></tr><tr><td>$X \leq 0.5\text{mm}$</td><td>$Y \leq 0.5\text{mm}$</td><td>$Z < \text{cover t hickness}$</td></tr></table>	X	Y	Z	$X \leq 0.5\text{mm}$	$Y \leq 0.5\text{mm}$	$Z < \text{cover t hickness}$																										
X	Y	Z																															
$X \leq 0.5\text{mm}$	$Y \leq 0.5\text{mm}$	$Z < \text{cover t hickness}$																															
X : length																																	
Y : width																																	
Z : height																																	



		CTP cover broken	X	Y	Z	
			$X \leq 0.3\text{mm}$	$Y \leq 0.3\text{mm}$	$Z < \text{cover thickness}$	
		X : length	* Circuitry broken is not allowed.			
		Y : width				
		Z : height				

Criteria (functional items)

Number	Items	Criteria (mm)
1	No display	Not allowed
2	Missing segment	Not allowed
3	Short	Not allowed
4	Backlight no lighting	Not allowed
5	CTP no function	Not allowed

10. Reliability Test Result

Item	Condition	Inspection after test
High Temperature Operating	70°C,96H	Inspection after 2~4hours storage at room temperature, the sample shall be free from defects: 1.Air bubble in the LCD; 2.Non-display; 3.Missing segments/line; 4.Glass crack; 5.Current IDD is twice higher than initial value.
Low Temperature Operating	-20°C, 96HR	
High Temperature Storage	80°C, 96HR	
Low Temperature Storage	-30°C, 96HR	
High Temperature & High Humidity Operating	+60°C, 90% RH ,96 hours.	
Thermal Shock (Non-operation)	-20°C,30 min ↔ 60°C,30 min, Change time:5min 20CYC.	
ESD test	C=150pF, R=330,5points/panel Air:±8KV, 5times; Contact:±6KV, 5 times; (Environment: 15°C~35°C, 30%~60%).	
Vibration (Non-operation)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total) (Package condition).	
Box Drop Test	1 Corner 3 Edges 6 faces,80cm(MEDIUM BOX)	

Remark:

- 1.The test samples should be applied to only one test item.
- 2.Sample size for each test item is 5~10pcs.
- 3.For Damp Proof Test, Pure water(Resistance > 10MΩ) should be used.
- 4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.
- 5.Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.
6. The color fading mura of polarizing filter should not care.

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11. Cautions and Handling Precautions

11.1 Handling and Operating the Module

(1) When the module is assembled, it should be attached to the system firmly.

Do not warp or twist the module during assembly work.

(2) Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.

(3) Note that polarizer is very fragile and could be easily damaged. Do not press or scratch the surface.

(4) Do not allow drops of water or chemicals to remain on the display surface.

If you have the droplets for a long time, staining and discoloration may occur.

(5) If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.

(6) The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane.

Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.

(7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.

(8) Protect the module from static; it may cause damage to the CMOS ICs.

(9) Use finger-stalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.

(10) Do not disassemble the module.

(11) Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.

(12) Pins of I/F connector shall not be touched directly with bare hands.

(13) Do not connect, disconnect the module in the "Power ON" condition.

(14) Power supply should always be turned on/off by the item 6.1 Power On Sequence & 6.2 Power Off Sequence

11.2 Storage and Transportation.

(1) Do not leave the panel in high temperature, and high humidity for a long time.

It is highly recommended to store the module with temperature from 0 to 35 °C and relative humidity of less than 70%

(2) Do not store the TFT-LCD module in direct sunlight.

(3) The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.

(4) It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module.

In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.

(5) This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.

Part. No	KD040HVFMD081-C050A	REV	V1.0	Page 37 of 38
常备库存 Stock For Sale	长期供货 Long Time supply	支持小量 NO MOQ	品种齐全 In Full Range	

12. Packing

----TBD-----



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常备库存 Stock For Sale	长期供货 Long Time supply	支持小量 NO MOQ	品种齐全 In Full Range	

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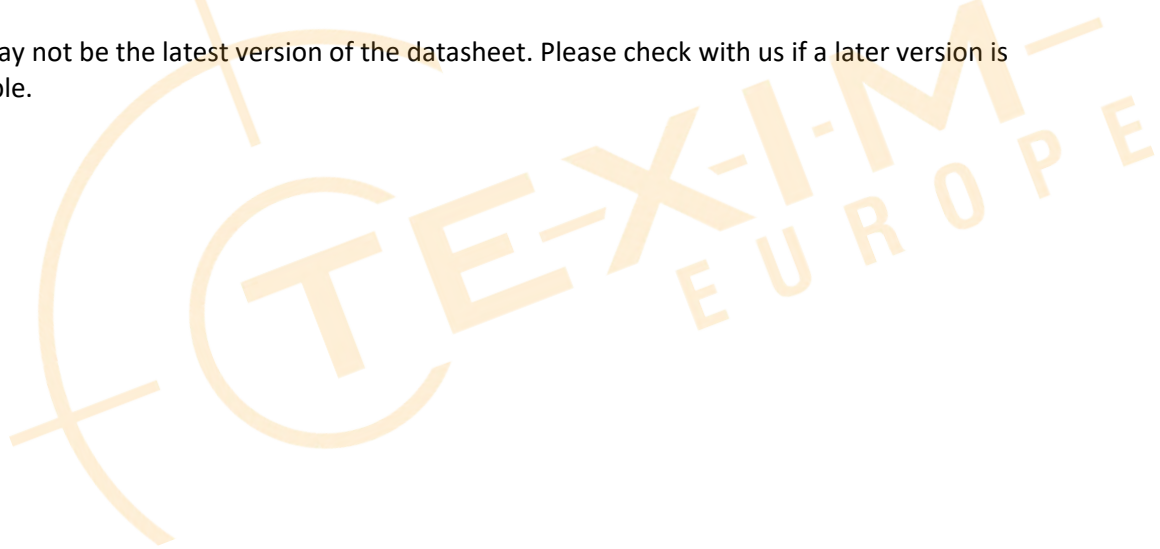
It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application.

Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time.

All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts.

Please contact us if you have any questions about the contents of the datasheet.

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